

Description

The AP7342 is a dual low dropout regulator with high output voltage accuracy, low $R_{DS(ON)}$, high PSRR, low output noise and low quiescent current. This regulator is based on a CMOS process.

Each regulator includes a voltage reference, error amplifier, current limit circuit and an enable input to turn on/off output. With the integrated resistor network, fixed output voltage versions can be delivered.

With its low power consumption and line and load transient response, the AP7342 is well suited for low power handheld communication equipment.

The AP7342 is packaged in X2-DFN1212-6 package and allows for smallest footprint and dense PCB layout.

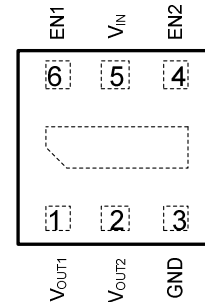
Features

- Low V_{IN} and Wide V_{IN} Range: 1.7V to 5.25V
- Guarantee Output Current: 150mA
- V_{OUT} Accuracy $\pm 1\%$
- Ripple Rejection: 75dB at 1kHz
- Low Output Noise: $60\mu V_{rms}$ from 10Hz to 100kHz
- Quiescent Current as Low as $35\mu A$
- V_{OUT} Fixed 1.2V to 3.6V
- **Totally Lead-Free & and Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free, Green Device (Note 3)**

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Assignments

Top View

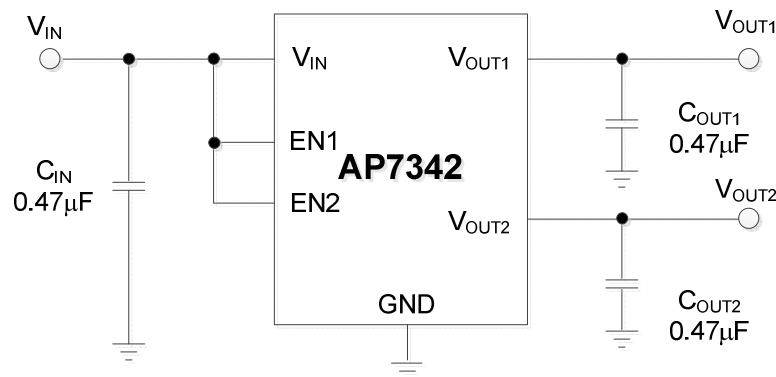


X2-DFN1212-6

Applications

- Smart Phone/PAD
- RF Supply
- Cameras
- Portable Video
- Portable Media Player
- Wireless Adapter
- Wireless Communication

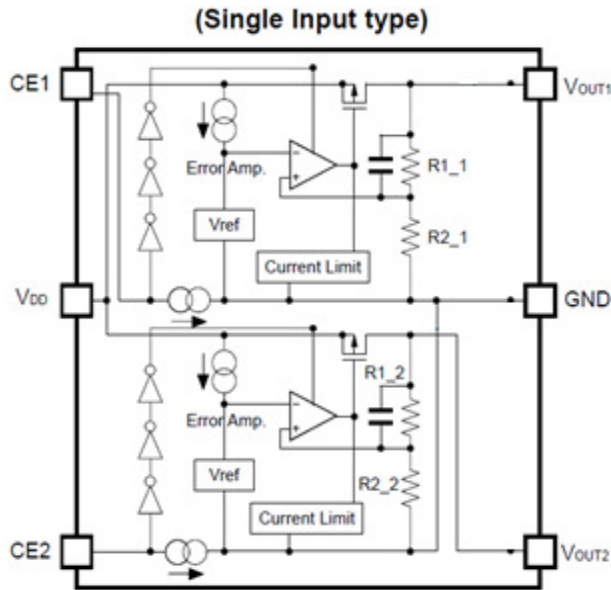
Typical Applications Circuit



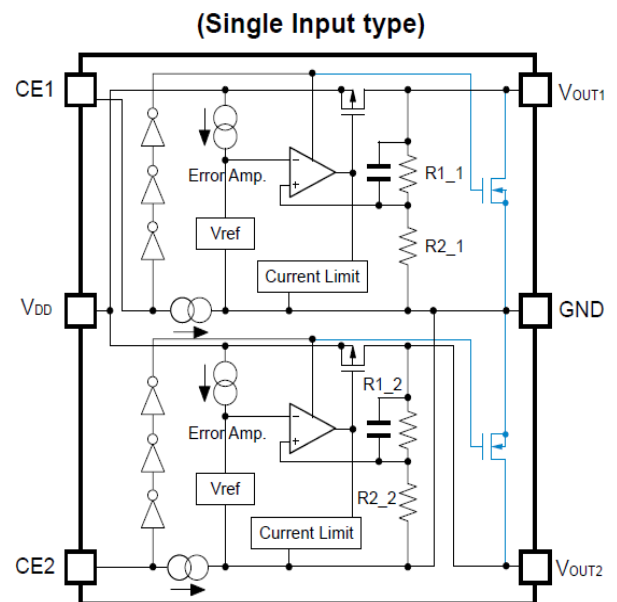
Pin Descriptions

| Pin Number | Pin Name | Function |
|------------|-------------------|---|
| 1 | V _{OUT1} | Channel 1 Output Voltage Pin |
| 2 | V _{OUT2} | Channel 2 Output Voltage Pin |
| 3 | GND | Ground |
| 4 | EN2 | Chanel 2 Enable Pin This pin should be driven either high or low and must not be floating. Driving this pin high enables channel 2 output, while pulling it low puts Chanel 2 regulator into shutdown mode. |
| 5 | V _{IN} | Power Input Pin |
| 6 | EN1 | Chanel 1 Enable Pin This pin should be driven either high or low and must not be floating. Driving this pin high enables channel 1 output, while pulling it low puts Chanel 1 regulator into shutdown mode. |
| – | Thermal PAD | In PCB layout, it is preferred to use large copper area to cover this pad for better thermal dissipation, then connect this area to GND or leave it open. However, do not use it as GND electrode function alone. |

Functional Block Diagram



AP7342 (No Discharge)



AP7342 (With Discharge)

Absolute Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.) (Note 4)

| Symbol | Parameter | Rating | Unit |
|-----------|-------------------------------|------------------------|------------------|
| V_{IN} | Input Voltage | 6.0 | V |
| V_{EN} | Input Voltage at EN Pins | 6.0 | V |
| V_{OUT} | Output Voltage | -0.3 to $V_{IN} + 0.3$ | V |
| I_{OUT} | Output Current | 180 | mA |
| P_D | Power Dissipation | 600 | mW |
| T_A | Operating Ambient Temperature | -40 to +85 | $^\circ\text{C}$ |
| T_{STG} | Storage Temperature | -55 to +125 | $^\circ\text{C}$ |

Note: 4. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Recommended Operating Conditions (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Symbol | Parameter | Min | Max | Unit |
|-----------|-------------------------------|-----|------|------------------|
| V_{IN} | Input Voltage | 1.7 | 5.25 | V |
| I_{OUT} | Output Current | 0 | 150 | mA |
| T_A | Operating Ambient Temperature | -40 | +85 | $^\circ\text{C}$ |

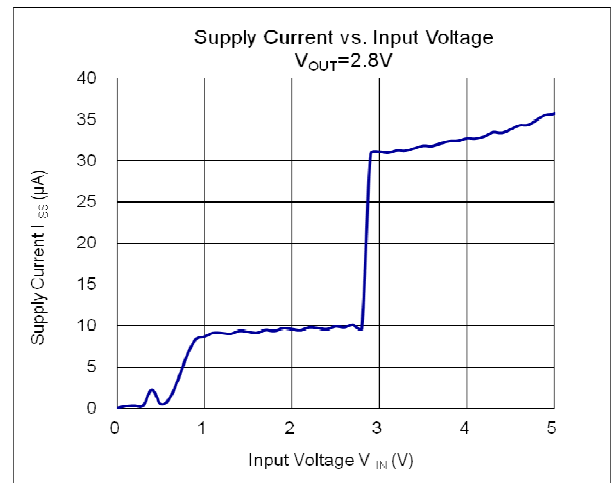
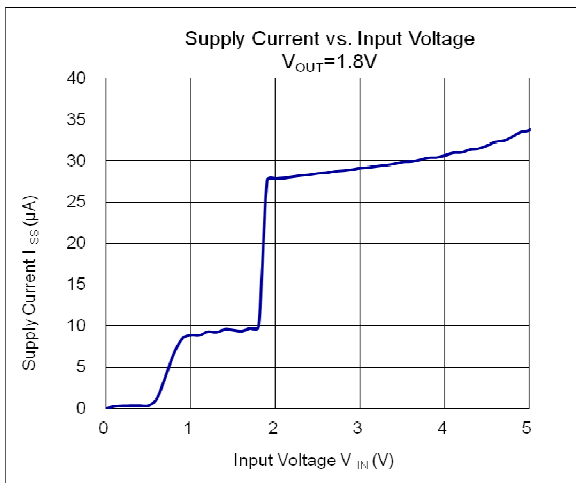
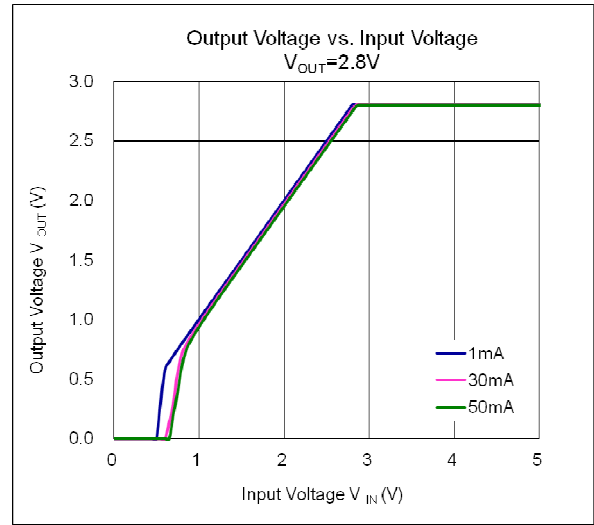
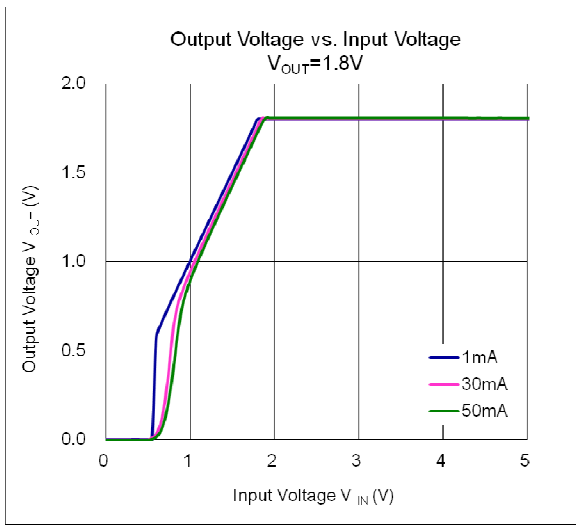
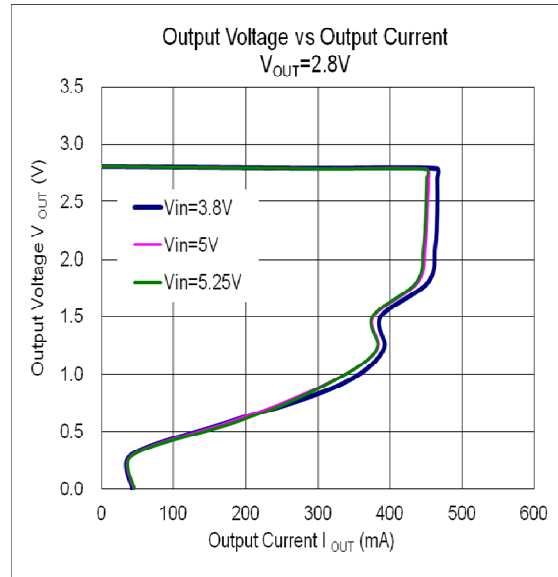
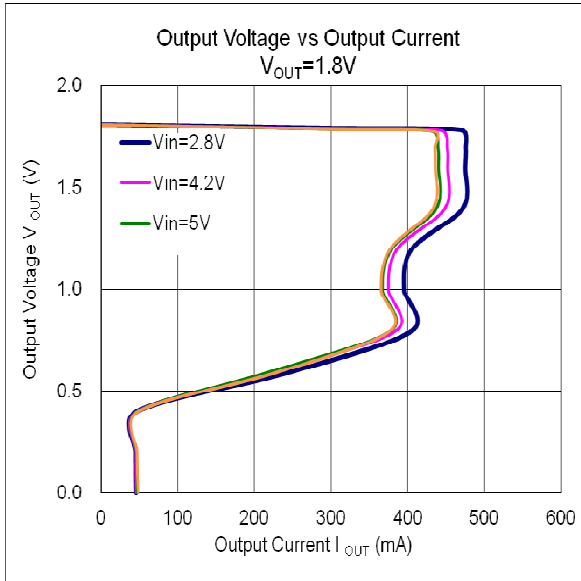
Electrical Characteristics

(@ $T_A = +25^\circ\text{C}$, $V_{IN} = V_{OUT} + 1\text{V}$ ($V_{OUT} > 1.5\text{V}$), $V_{IN} = 2.5\text{V}$ ($V_{OUT} \leq 1.5\text{V}$), $I_{OUT} = 1\text{mA}$, $C_{IN} = C_{OUT} = 1.0\mu\text{F}$, unless otherwise specified.)

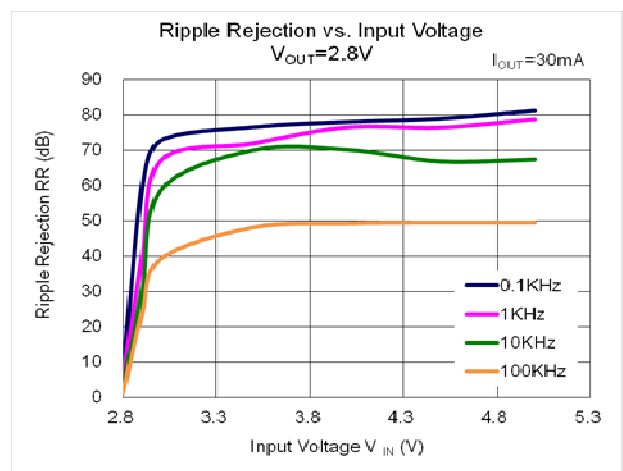
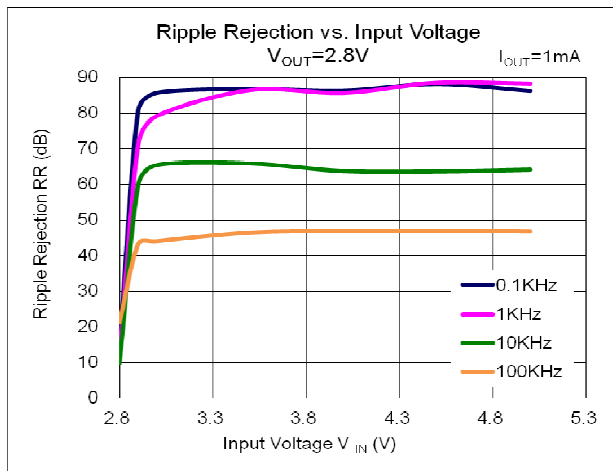
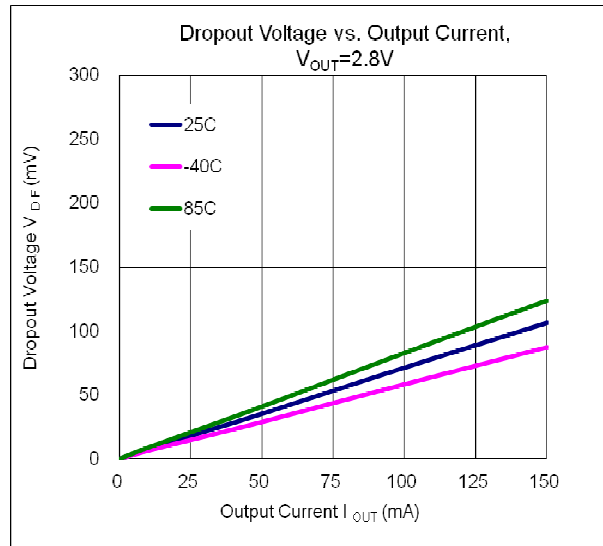
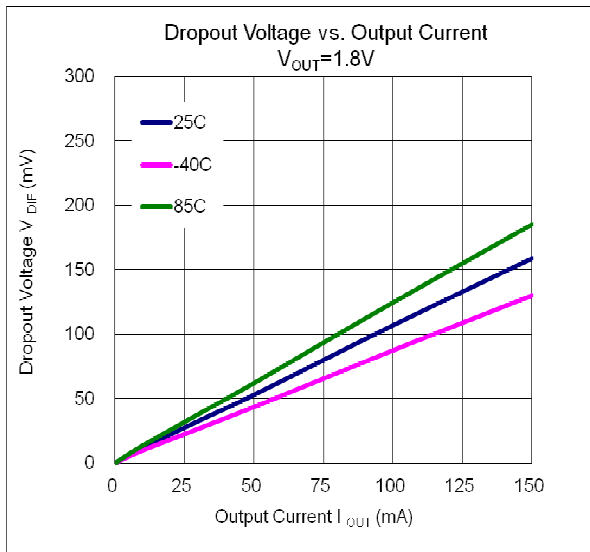
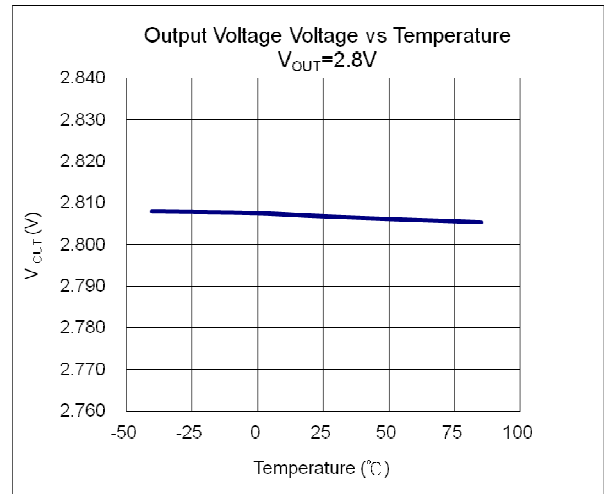
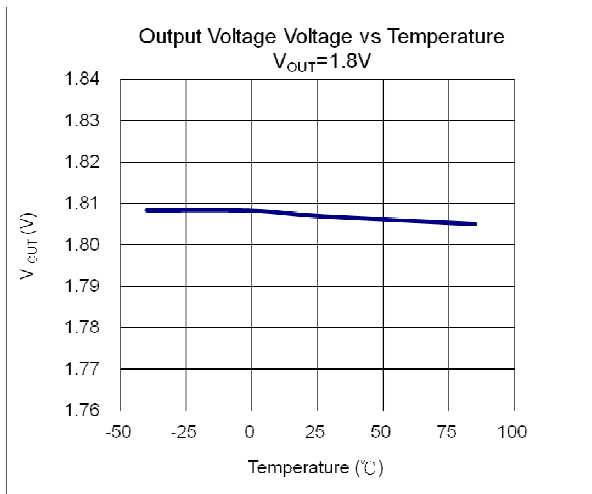
| Parameter | Conditions | Min | Typ | Max | Unit | |
|--|--|--|----------|------|-----------------------|----------|
| Input Voltage | $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | 1.7 | – | 5.25 | V | |
| Output Voltage Accuracy (Note 11) | $V_{IN} = (V_{OUT-Nom} + 1.0\text{V})$ to 5.25V , $I_{OUT} = 1\text{mA}$ to 150mA | $T_A = +25^\circ\text{C}$ | -1 | – | 1 | % |
| | | $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | -1.5 | – | 1.5 | |
| Line Regulation ($\Delta V_{OUT}/\Delta V_{IN}/V_{OUT}$) | $V_{IN} = (V_{OUT-Nom} + 1.0\text{V})$ to 5.25V , $I_{OUT} = 1.0\text{mA}$ | – | 0.02 | 0.1 | %/V | |
| Load Regulation ($\Delta V_{OUT}/\Delta I_{OUT}$) | $V_{IN} = V_{OUT-Nom} + 1.0\text{V}$, $I_{OUT} = 1\text{mA}$ to 150mA | – | 15 | 30 | mV | |
| Quiescent Current (Note 6) | Set EN1 high, set EN2 low, or set EN2 high, set EN1 low, No load | – | 35 | 50 | μA | |
| | Set EN1/EN2 high, No load | – | 70 | 100 | μA | |
| $I_{STANDBY}$ | Set EN1/EN2 low, No load | – | 0.1 | 1.0 | μA | |
| Output Current | – | 300 | – | – | mA | |
| Fold-back Short Current (Note 7) | V_{OUT} short to ground | – | 55 | – | mA | |
| PSRR (Note 8) | $V_{IN} = (V_{OUT} + 1\text{V}) V_{DC} + 0.2\text{Vp-pAC}$, $V_{OUT} \geq 1.8\text{V}$, $I_{OUT} = 30\text{mA}$ | – | 75 | – | dB | |
| Output Noise Voltage (Notes 8 & 9) | $BW = 10\text{Hz}$ to 100kHz , $I_{OUT} = 30\text{mA}$ | – | 60 | – | μVrms | |
| Dropout Voltage (Note 5) | $I_{OUT} = 150\text{mA}$ | $V_{OUT} \leq 1.2\text{V}$ | – | 0.48 | 0.59 | V |
| | | $1.2\text{V} < V_{OUT} \leq 1.4\text{V}$ | – | 0.39 | 0.50 | |
| | | $1.4\text{V} < V_{OUT} \leq 1.7\text{V}$ | – | 0.35 | 0.44 | |
| | | $1.7\text{V} < V_{OUT} \leq 2.1\text{V}$ | – | 0.30 | 0.39 | |
| | | $2.1\text{V} < V_{OUT} \leq 2.5\text{V}$ | – | 0.26 | 0.34 | |
| | | $2.5\text{V} < V_{OUT} \leq 3.0\text{V}$ | – | 0.25 | 0.30 | |
| | | $3.0\text{V} < V_{OUT} \leq 3.6\text{V}$ | – | 0.22 | 0.29 | |
| Output Voltage Temperature Coefficient | $I_{OUT} = 30\text{mA}$, $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | – | ± 30 | – | ppm/ $^\circ\text{C}$ | |
| EN Input Low Voltage | – | 0 | – | 0.5 | V | |
| EN Input High Voltage | – | 1.3 | – | 5.25 | V | |
| EN Input Leakage | $V_{EN} = 0\text{V}$, $V_{IN} = 5.0\text{V}$ or $V_{EN} = 5.0\text{V}$, $V_{IN} = 0\text{V}$ | -1.0 | – | 1.0 | μA | |
| On Resistance of N-Channel for Auto-Discharge (Note 10) | $V_{IN} = 4.0\text{V}$, $V_{EN} = 0\text{V}$ (Disabled) | D Version, Chanel 1 & 2 | – | 50 | – | Ω |

- Notes:
- Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.
 - Quiescent current is defined here is the difference in current between the input and the output.
 - Short circuit current is measured with V_{OUT} pulled to GND.
 - This specification is guaranteed by design.
 - To make sure lowest environment noise minimizes the influence on noise measurement.
 - AP7342 has 2 options for output, built-in discharge and non-discharge
 - Potential multiple grades based on following output voltage accuracy.

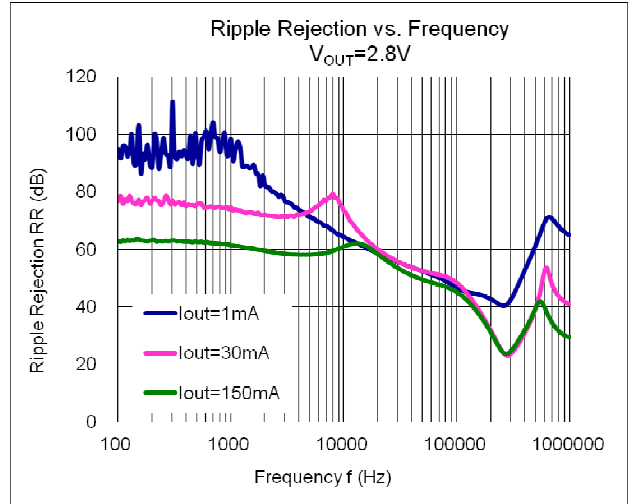
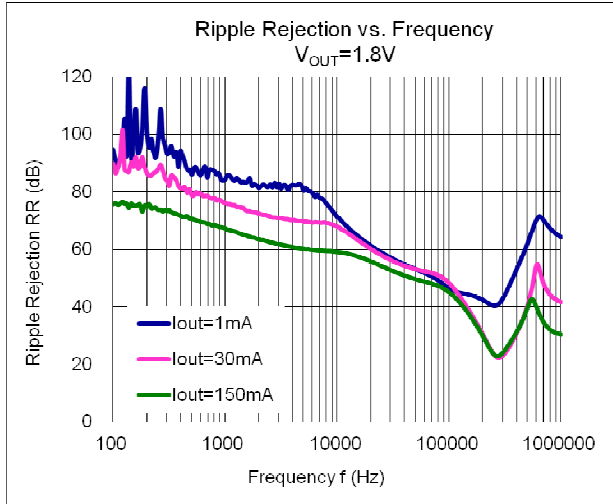
Typical Characteristics



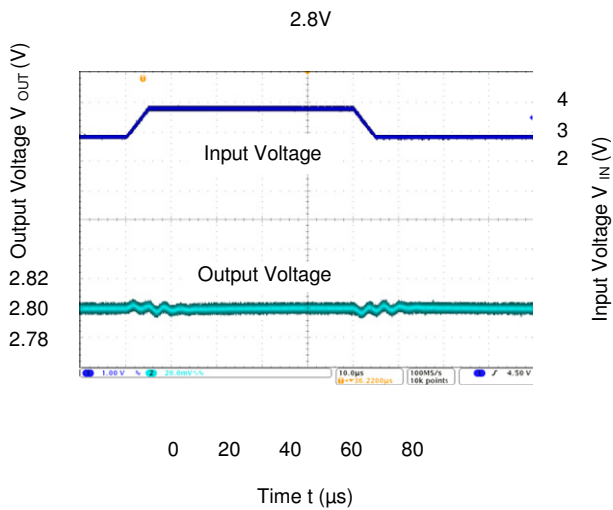
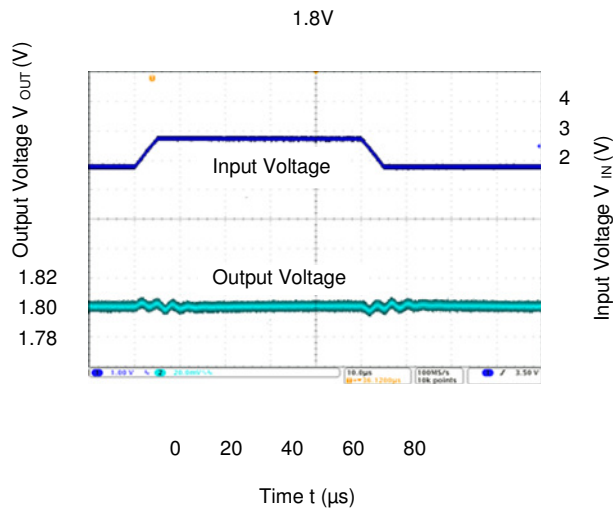
Typical Characteristics (cont.)



Typical Characteristic (cont.)

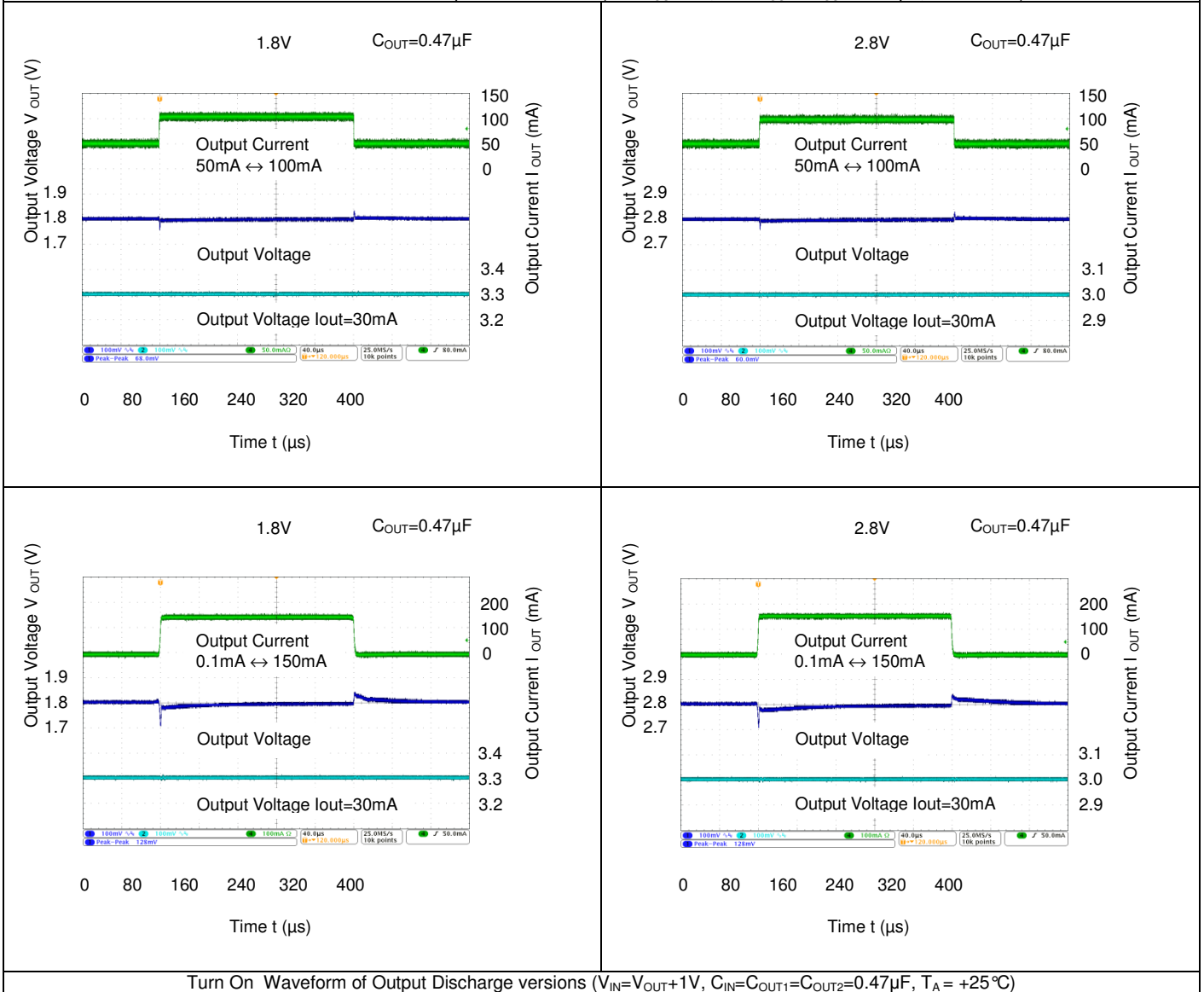


Load Transient Response Waveforms ($V_{IN}=V_{OUT}+1V$, $C_{IN}=C_{OUT1}=C_{OUT2}=0.47\mu F$, $T_A=25^\circ C$)

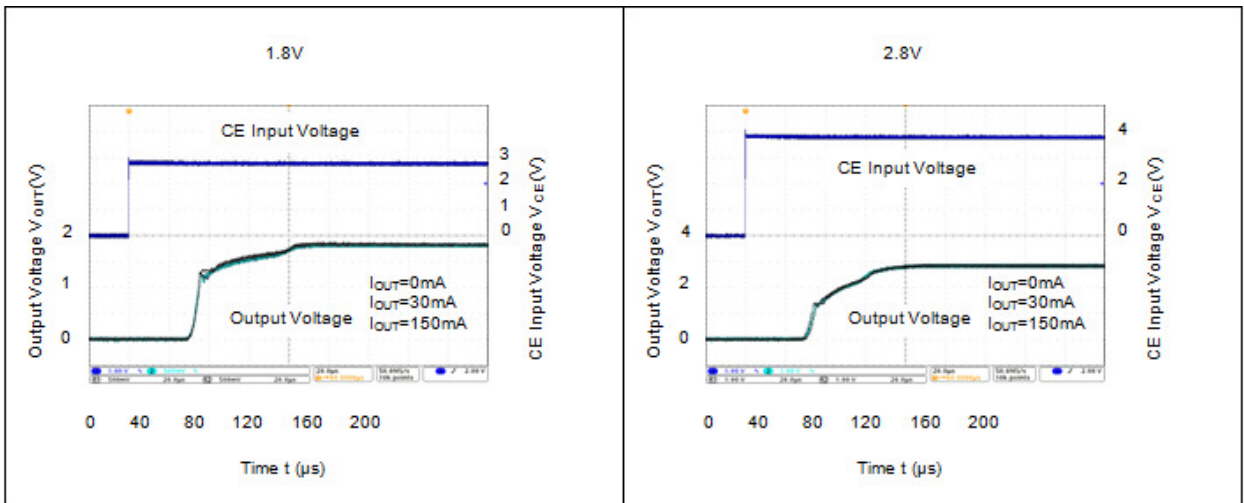


Typical Characteristics (cont.)

Load Transient Response Waveforms ($V_{IN}=V_{OUT}+1V$, $C_{IN}=C_{OUT1}=C_{OUT2}=0.47\mu F$, $T_A = +25^\circ C$)

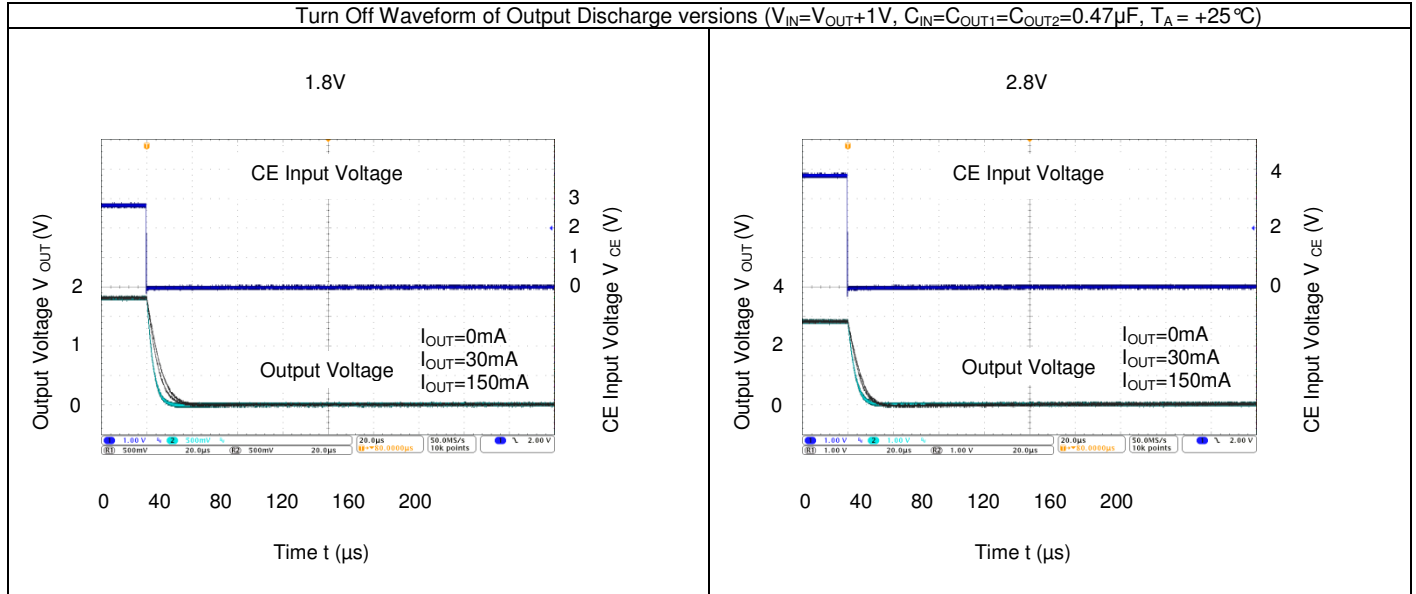


Turn On Waveform of Output Discharge versions ($V_{IN}=V_{OUT}+1V$, $C_{IN}=C_{OUT1}=C_{OUT2}=0.47\mu F$, $T_A = +25^\circ C$)



Typical Characteristics (cont.)

Turn Off Waveform of Output Discharge versions ($V_{IN}=V_{OUT}+1V$, $C_{IN}=C_{OUT1}=C_{OUT2}=0.47\mu F$, $T_A = +25^\circ C$)



Application Information

Output Capacitor

An output capacitor (C_{OUT}) is needed to improve transient response and maintain stability. The AP7342 is stable with very small ceramic output capacitors. The ESR (Equivalent Series Resistance) and capacitance drives the selection. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the GND pin and care should be taken to reduce the impedance in the layout.

Input Capacitor

To prevent the input voltage from dropping during load steps, it is recommended to utilize an input capacitor (C_{IN}). A minimum $0.47\mu F$ ceramic capacitor is recommended between V_{IN} and GND pin to decouple input power supply glitch. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both V_{IN} and GND pin.

Enable Control

The AP7342 is turned on by setting the EN pins high, and is turned off by pulling it low. If this feature is not used, the EN pins should be tied to V_{IN} pin to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pins must be able to swing above and below the specified turn-on/off voltage thresholds listed in the Electrical Characteristics section.

Short Circuit Protection

When V_{OUT} pins are short-circuit to GND, short circuit protection will be triggered and clamp the output current to approximately 60mA. This feature protects the regulator from overcurrent and damage due to overheating.

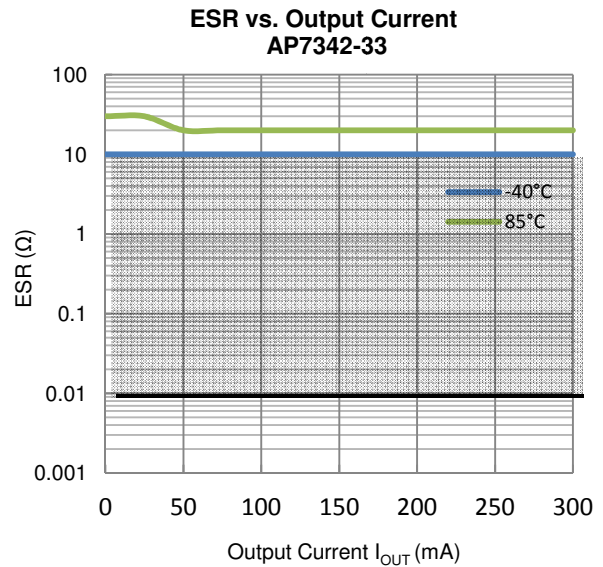
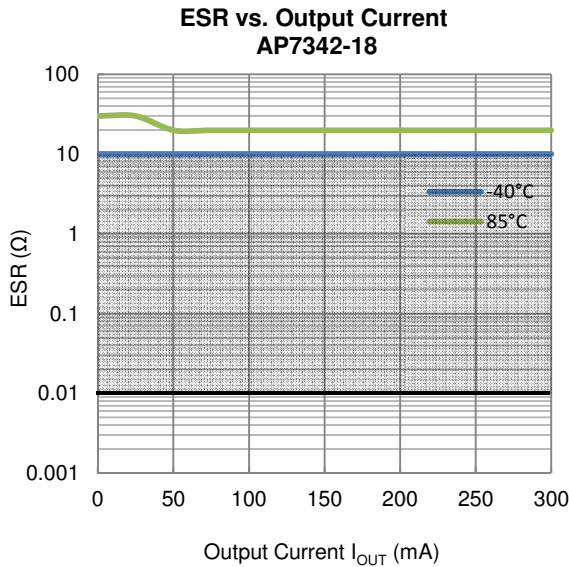
Layout Considerations

For good ground loop and stability, the input and output capacitors should be located close to the input, output, and GND pin of the device. The regulator GND pin should be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance. Wide trace should be used for large current paths from V_{IN} to V_{OUT} and load circuit.

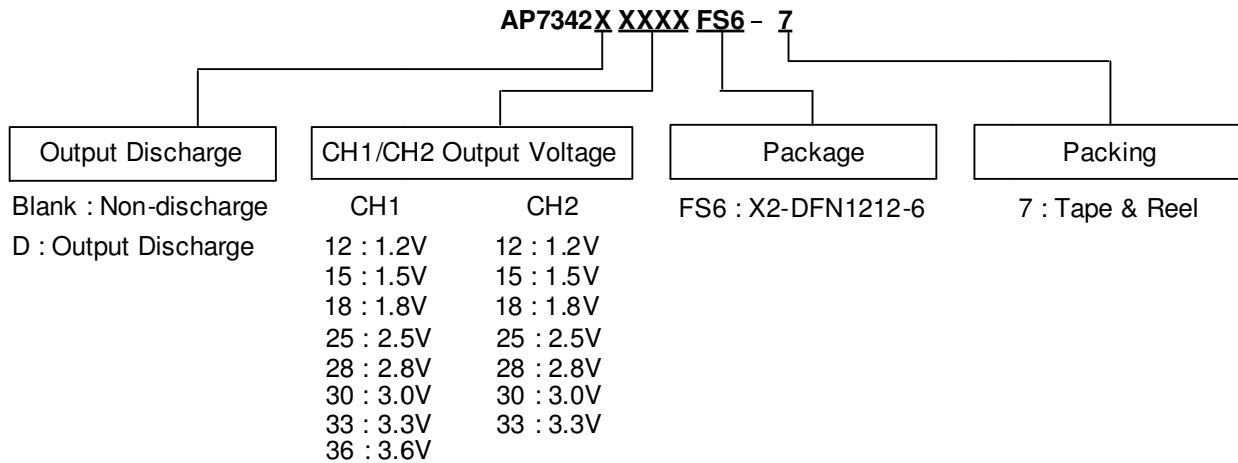
ESR vs. Output Current

Ceramic type output capacitor is recommended for this series; however, the other output capacitors with low ESR can also be used. The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown below. The stable region is marked as the hatched area in the graph.

Measurement Conditions: Frequency Band: 10Hz to 2MHz, Temperature: -40°C to $+85^{\circ}\text{C}$.



Ordering Information

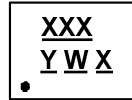


| Device | Package Code | Packaging | 7" Tape and Reel | |
|-------------------|--------------|--------------|-------------------|--------------------|
| | | | Quantity | Part Number Suffix |
| AP7342-XXXXFS6-7 | FS6 | X2-DFN1212-6 | 5,000/Tape & Reel | -7 |
| AP7342D-XXXXFS6-7 | FS6 | X2-DFN1212-6 | 5,000/Tape & Reel | -7 |

Marking Information

(1) X2-DFN1212-6

(Top View)



XXX : Identification Code

Y : Year : 0~9

W : Week : A~Z : 1~26 week;

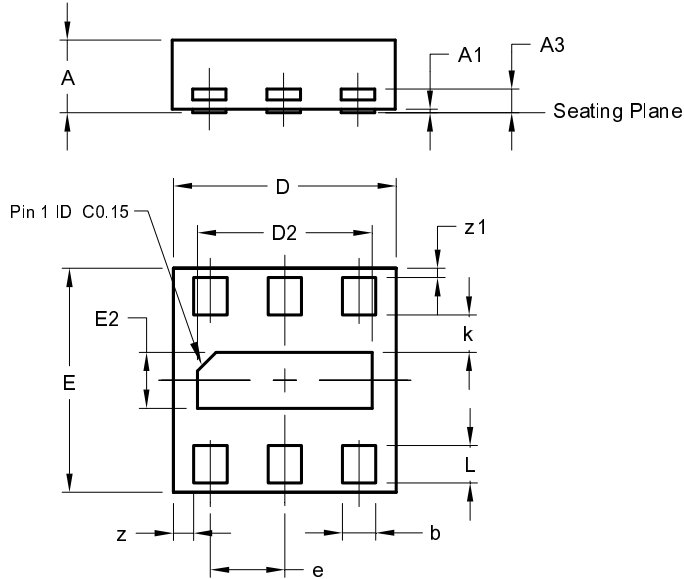
a~z : 27~52 week; z represents
52 and 53 week

X : Internal code

| Part Number | V _{OUT1} /V _{OUT2} | Package | Identification Code |
|-------------------|--------------------------------------|--------------|---------------------|
| AP7342-3028FS6-7 | 3.0V/2.8V | X2-DFN1212-6 | CAA |
| AP7342-3328FS6-7 | 3.3V/2.8V | X2-DFN1212-6 | CAB |
| AP7342D-1218FS6-7 | 1.2V/1.8V | X2-DFN1212-6 | CAC |
| AP7342D-1528FS6-7 | 1.5V/2.8V | X2-DFN1212-6 | CAD |
| AP7342D-1815FS6-7 | 1.8V/1.5V | X2-DFN1212-6 | CAE |
| AP7342D-1818FS6-7 | 1.8V/1.8V | X2-DFN1212-6 | CAF |
| AP7342D-1828FS6-7 | 1.8V/2.8V | X2-DFN1212-6 | CAG |
| AP7342D-1833FS6-7 | 1.8V/3.3V | X2-DFN1212-6 | CAH |
| AP7342D-2518FS6-7 | 2.5V/1.8V | X2-DFN1212-6 | CAJ |
| AP7342D-2812FS6-7 | 2.8V/1.2V | X2-DFN1212-6 | CAK |
| AP7342D-2818FS6-7 | 2.8V/1.8V | X2-DFN1212-6 | CAM |
| AP7342D-2825FS6-7 | 2.8V/2.5V | X2-DFN1212-6 | CAN |
| AP7342D-2833FS6-7 | 2.8V/3.3V | X2-DFN1212-6 | CAP |
| AP7342D-3018FS6-7 | 3.0V/1.8V | X2-DFN1212-6 | CAR |
| AP7342D-3028FS6-7 | 3.0V/2.8V | X2-DFN1212-6 | CAS |
| AP7342D-3030FS6-7 | 3.0V/3.0V | X2-DFN1212-6 | CAT |
| AP7342D-3318FS6-7 | 3.3V/1.8V | X2-DFN1212-6 | CAU |
| AP7342D-3328FS6-7 | 3.3V/2.8V | X2-DFN1212-6 | CAV |
| AP7342D-3330FS6-7 | 3.3V/3.0V | X2-DFN1212-6 | CAW |
| AP7342D-3333FS6-7 | 3.3V/3.3V | X2-DFN1212-6 | CAX |
| AP7342D-3612FS6-7 | 3.6V/1.2V | X2-DFN1212-6 | CAY |

Package Outline Dimensions (All dimensions in mm.)

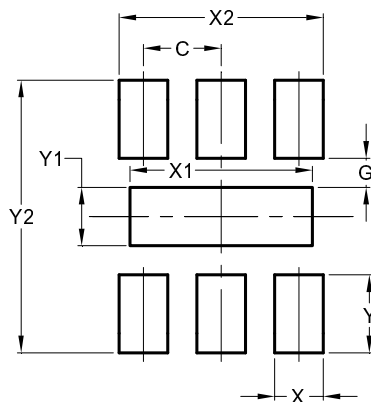
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



| X2-DFN1212-6 | | | |
|----------------------|------|------|-------|
| Dim | Min | Max | Typ |
| A | - | 0.40 | 0.39 |
| A1 | 0.00 | 0.05 | 0.020 |
| A3 | - | - | 0.13 |
| b | 0.13 | 0.23 | 0.18 |
| D | 1.15 | 1.25 | 1.20 |
| D2 | 0.89 | 0.99 | 0.94 |
| E | 1.15 | 1.25 | 1.20 |
| E2 | 0.25 | 0.35 | 0.30 |
| e | - | - | 0.40 |
| k | 0.15 | 0.25 | 0.20 |
| L | 0.15 | 0.25 | 0.20 |
| z | - | - | 0.11 |
| z1 | - | - | 0.05 |
| All Dimensions in mm | | | |

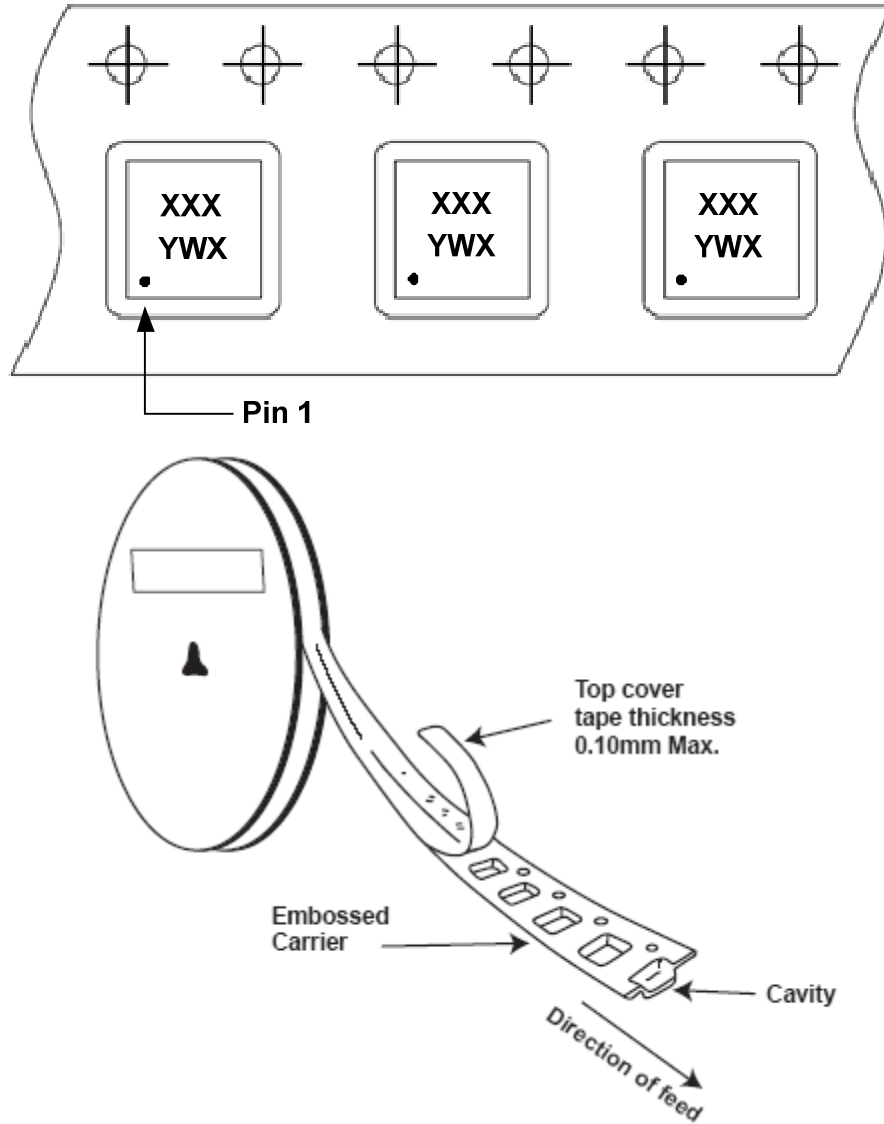
Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.400 |
| G | 0.150 |
| X | 0.250 |
| X1 | 0.940 |
| X2 | 1.050 |
| Y | 0.400 |
| Y1 | 0.300 |
| Y2 | 1.400 |

Tape Orientation



Note: The taping orientation of the other package type can be found on our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

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1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

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